

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT4703586

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DEOK HYUN AHN	11/24/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SPIGEN KOREA CO., LTD
<b>Street Address:</b>	GASANDIGITAL 1-RO 128, STX-V TOWER #1709, GASAN-DONG, GEUMCHEON-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29625646
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<b>ATTORNEY DOCKET NUMBER:</b>	7108PAT329
<b>NAME OF SUBMITTER:</b>	HEEDONG CHAE
<b>SIGNATURE:</b>	/hc/
<b>DATE SIGNED:</b>	11/27/2017
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 2</b>	
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source=signed_7108PAT329-Assignment#page2.tif	

**ASSIGNMENT**

WHEREAS, I, **Deok Hyun Ahn** (hereafter, together with any successors, legal representatives or assigns thereof, called "Assignors"), invented certain new and useful invention and/or improvements disclosed in an application for United States Letters Patent titled:

"CASE FOR ELECTRONIC DEVICES"

Filed: 11/10/2017  
Application Serial No.: 29/625,646

AND WHEREAS, **SPIGEN KOREA CO., LTD.**, residing at Gasandigital 1-ro 128, STX-V tower #1709, Gasan-dong, GEUMCHEON-GU, SEOUL, Republic of Korea (hereafter, together with any successors, legal representatives or assigns thereof, called "Assignees"), wants to acquire the entire right, title and interest in and to said improvements and application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, Assignors have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignees the entire right, title and interest in and to said invention and/or improvements, and said application and all divisions, substitutions, continuations, and continuations-in-part thereof, and all United States Letters Patents (and all other patents) which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, inventor's certificates, and the like) heretofore or hereafter filed for said invention and/or improvements in any foreign countries, and all patents (including all extensions, renewals and reissues thereof) granted for said invention and/or improvements in any foreign countries.

ASSIGNORS HEREBY authorize and require the United States Patent and Trademark Office to issue all patents for said invention and/or improvements to Assignees in accordance with the terms of this assignment. The right, title and interest is to be held and enjoyed by Assignees and Assignees' successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignors had this assignment not been made.

AND ASSIGNORS HEREBY covenant that Assignors have full right to convey the entire interest herein assigned, and that Assignors have not executed, and will not execute, any agreement in conflict herewith;

AND ASSIGNORS HEREBY further covenant and agree that Assignors will communicate to Assignee any facts known to us respecting said invention and/or improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional continuation, continuations legal proceeding, sign all lawful papers, execute all

